

# **Excellent Integrated System Limited**

Stocking Distributor

Click to view price, real time Inventory, Delivery & Lifecycle Information:

<u>Texas Instruments</u> <u>SN74LVC8T245MPWREP</u>

For any questions, you can email us directly: sales@integrated-circuit.com



SN74LVC8T245-EP

SCES770-DECEMBER 2008 www.ti.com

# 8-BIT DUAL-SUPPLY BUS TRANSCEIVER WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS

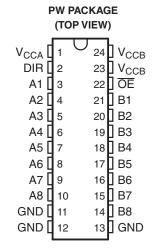
#### **FEATURES**

- Control Inputs VIH/VIL Levels Are Referenced to V<sub>CCA</sub> Voltage
- V<sub>CC</sub> Isolation Feature If Either V<sub>CC</sub> Input Is at GND, All Are in the High-Impedance State
- **Fully Configurable Dual-Rail Design Allows** Each Port to Operate Over the Full 1.65-V to 5.5-V Power-Supply Range
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- **ESD Protection Exceeds JESD 22** 
  - 4000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)

#### SUPPORTS DEFENSE, AEROSPACE, AND MEDICAL APPLICATIONS

- **Controlled Baseline**
- One Assembly/Test Site
- One Fabrication Site
- Available in Military (-55°C/125°C) Temperature Range(1)
- **Extended Product Life Cycle**
- **Extended Product-Change Notification**
- **Product Traceability**

(1) Additional temperature ranges are available – contact factory



#### **DESCRIPTION/ORDERING INFORMATION**

This 8-bit noninverting bus transceiver uses two separate configurable power-supply rails. The SN74LVC8T245 is optimized to operate with V<sub>CCA</sub> and V<sub>CCB</sub> set at 1.65 V to 5.5 V. The A port is designed to track V<sub>CCA</sub>. V<sub>CCA</sub> accepts any supply voltage from 1.65 V to 5.5 V. The B port is designed to track V<sub>CCB</sub>. V<sub>CCB</sub> accepts any supply voltage from 1.65 V to 5.5 V. This allows for universal low-voltage bidirectional translation between any of the 1.8-V, 2.5-V, 3.3-V, and 5.5-V voltage nodes.

## ORDERING INFORMATION(1)

$T_A$	PACKAGI	<u>=</u> (2)	ORDERABLE PART NUMBER	TOP-SIDE MARKING	
-55°C to 125°C	TSSOP – PW	Tape and reel	SN74LVC8T245MPWREP	NH245MEP	

- For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI Web site at www.ti.com.
- Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

SN74LVC8T245-EP



SCES770-DECEMBER 2008 www.ti.com

#### **DESCRIPTION/ORDERING INFORMATION (CONTINUED)**

The SN74LVC8T245 is designed for asynchronous communication between two data buses. The logic levels of the direction-control (DIR) input and the output-enable  $(\overline{OE})$  input activate either the B-port outputs or the A-port outputs or place both output ports into the high-impedance mode. The device transmits data from the A bus to the B bus when the B-port outputs are activated, and from the B bus to the A bus when the A-port outputs are activated. The input circuitry on both A and B ports is always active and must have a logic HIGH or LOW level applied to prevent excess  $I_{CC}$  and  $I_{CCZ}$ .

The SN74LVC8T245 is designed so that the control pins (DIR and  $\overline{OE}$ ) are supplied by V<sub>CCA</sub>.

This device is fully specified for partial-power-down applications using  $I_{off}$ . The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

The  $V_{CC}$  isolation feature ensures that if either  $V_{CC}$  input is at GND, all outputs are in the high-impedance state.

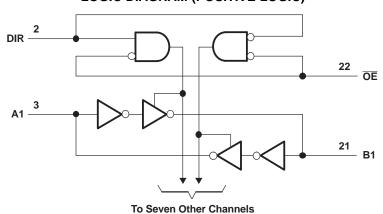
To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

#### FUNCTION TABLE<sup>(1)</sup> (EACH 8-BIT SECTION)

CONTRO	L INPUTS	OUTPUT (	CIRCUITS	OPERATION		
ŌE	DIR	A PORT	B PORT	OPERATION		
L	L	Enabled	Hi-Z	B data to A bus		
L	Н	Hi-Z	Enabled	A data to B bus		
Н	Χ	Hi-Z	Hi-Z	Isolation		

(1) Input circuits of the data I/Os are always active.

#### **LOGIC DIAGRAM (POSITIVE LOGIC)**



Submit Documentation Feedback

Datasheet of SN74LVC8T245MPWREP - IC BUS TRANSCVR 8BIT 24TSSOP Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

SN74LVC8T245-EP



www.ti.com SCES770-DECEMBER 2008

## Absolute Maximum Ratings(1)

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
$V_{CCA}$	Supply voltage range		-0.5	6.5	V
		I/O ports (A port)	-0.5	6.5	
$V_{I}$	Input voltage range (2)	I/O ports (B port)	-0.5	6.5	V
		Control inputs	-0.5	6.5	
V	Voltage range applied to any output	A port	-0.5	6.5	V
Vo	in the high-impedance or power-off state (2)	B port	-0.5	6.5	V
V	Valtage range applied to any output in the high or law state (2)(3)	A port	-0.5	V <sub>CCA</sub> + 0.5	V
Vo	Voltage range applied to any output in the high or low state (2)(3)	B port	-0.5	V <sub>CCB</sub> + 0.5	V
I <sub>IK</sub>	Input clamp current	V <sub>I</sub> < 0		<b>-</b> 50	mA
I <sub>OK</sub>	Output clamp current	V <sub>O</sub> < 0		<b>-</b> 50	mA
Io	Continuous output current			±50	mA
	Continuous current through each V <sub>CCA</sub> , V <sub>CCB</sub> , and GND			±100	mA
$\theta_{JA}$	Package thermal impedance (4)			88	°C/W
T <sub>stg</sub>	Storage temperature range		-65	150	°C

<sup>(1)</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

<sup>(2)</sup> The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.

<sup>(3)</sup> The output positive-voltage rating may be exceeded up to 6.5 V maximum if the output current rating is observed.

<sup>(4)</sup> The package thermal impedance is calculated in accordance with JESD 51-7.

Datasheet of SN74LVC8T245MPWREP - IC BUS TRANSCVR 8BIT 24TSSOP Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

SN74LVC8T245-EP



SCES770-DECEMBER 2008 www.ti.com

# Recommended Operating Conditions (1)(2)(3)(4)

			V <sub>CCI</sub>	V <sub>cco</sub>	MIN	MAX	UNIT
$V_{CCA}$	0				1.65	5.5	V
$V_{CCB}$	Supply voltage				1.65	5.5	V
	I		1.65 V to 1.95 V		V <sub>CCI</sub> × 0.65		
.,	High-level	D ( (5)	2.3 V to 2.7 V		1.7		
$V_{IH}$	input voltage	Data inputs <sup>(5)</sup>	3 V to 3.6 V		2		V
			4.5 V to 5.5 V		$V_{CCI} \times 0.7$		
			1.65 V to 1.95 V			$V_{CCI} \times 0.35$	
.,	Low-level	D ( (5)	2.3 V to 2.7 V			0.7	
$V_{IL}$	input voltage	Data inputs <sup>(5)</sup>	3 V to 3.6 V			0.8	V
			4.5 V to 5.5 V			V <sub>CCI</sub> × 0.3	
	High-level Control inputs		1.65 V to 1.95 V		V <sub>CCA</sub> × 0.65		
$V_{IH}$			2.3 V to 2.7 V		1.7		V
VIП	input voltage	(referenced to V <sub>CCA</sub> ) <sup>(6)</sup>	3 V to 3.6 V		2		•
			4.5 V to 5.5 V		V <sub>CCA</sub> × 0.7		
	Low-level input voltage		1.65 V to 1.95 V			V <sub>CCA</sub> × 0.35	
$V_{IL}$		Control inputs	2.3 V to 2.7 V			0.7	V
* IL		(referenced to V <sub>CCA</sub> ) <sup>(6)</sup>	3 V to 3.6 V			0.8	•
			4.5 V to 5.5 V			V <sub>CCA</sub> × 0.3	
VI	Input voltage	Control inputs			0	5.5	V
	Input/output	Active state			0	$V_{CCO}$	V
$V_{I/O}$	voltage	3-State			0	5.5	V
				1.65 V to 1.95 V		-4	
	TP-1 11 - 4- 4			2.3 V to 2.7 V		-8	
I <sub>OH</sub>	High-level output	current		3 V to 3.6 V		-24	mA
				4.5 V to 5.5 V		-32	
				1.65 V to 1.95 V		4	
	I am lamal amend			2.3 V to 2.7 V		8	Λ
l <sub>OL</sub>	Low-level output of	current		3 V to 3.6 V		24	mA
				4.5 V to 5.5 V		32	
			1.65 V to 1.95 V			20	
۸4/۸۰۰	Input transition	Data innuta	2.3 V to 2.7 V			20	na/\/
Δt/Δv	rise or fall rate	Data inputs	3 V to 3.6 V			10	ns/V
			4.5 V to 5.5 V			5	
T <sub>A</sub>	Operating free-air	temperature			-55	125	°C

 $V_{CCI}$  is the  $V_{CC}$  associated with the data input port.  $V_{CCO}$  is the  $V_{CC}$  associated with the output port. All unused or driven (floating) data inputs (I/Os) of the device must be held at logic HIGH or LOW (preferably  $V_{CCI}$  or GND) to ensure proper device operation and minimize power. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature

All unused control inputs must be held at  $V_{CCA}$  or GND to ensure proper device operation and minimize power comsumption. For  $V_{CCI}$  values not specified in the data sheet,  $V_{IH}$  min =  $V_{CCI}$  × 0.7 V,  $V_{IL}$  max =  $V_{CCI}$  × 0.3 V. For  $V_{CCA}$  values not specified in the data sheet,  $V_{IH}$  min =  $V_{CCA}$  × 0.7 V,  $V_{IL}$  max =  $V_{CCA}$  × 0.3 V.

Datasheet of SN74LVC8T245MPWREP - IC BUS TRANSCVR 8BIT 24TSSOP Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

SN74LVC8T245-EP



www.ti.com SCES770-DECEMBER 2008

# Electrical Characteristics (1)(2)

over recommended operating free-air temperature range (unless otherwise noted)

PARA	METER	TEST CONDI	TIONS	V <sub>CCA</sub>	V <sub>CCB</sub>	MIN	TYP	MAX	MIN	MAX	UNIT	
		$I_{OH} = -100 \mu A$ ,	$V_I = V_{IH}$	1.65 V to 4.5 V	1.65 V to 4.5 V				V <sub>CCO</sub> - 0.1			
		$I_{OH} = -4 \text{ mA},$	$V_I = V_{IH}$	1.65 V	1.65 V				1.2			
$V_{OH}$		$I_{OH} = -8 \text{ mA},$	$V_I = V_{IH}$	2.3 V	2.3 V				1.9		V	
		$I_{OH} = -24 \text{ mA},$	$V_I = V_{IH}$	3 V	3 V				2.4			
		$I_{OH} = -32 \text{ mA},$	$V_I = V_{IH}$	4.5 V	4.5 V				3.8			
		$I_{OL} = 100 \mu A$ ,	$V_I = V_{IL}$	1.65 V to 4.5 V	1.65 V to 4.5 V					0.1		
		$I_{OL} = 4 \text{ mA},$	$V_I = V_{IL}$	1.65 V	1.65 V					0.45		
$V_{OL}$		I <sub>OL</sub> = 8 mA,	$V_I = V_{IL}$	2.3 V	2.3 V					0.3	V	
		$I_{OL} = 24 \text{ mA},$	$V_I = V_{IL}$	3 V	3 V					0.55		
		I <sub>OL</sub> = 32 mA,	$V_I = V_{IL}$	4.5 V	4.5 V					0.55		
I	DIR	$V_I = V_{CCA}$ or GND		1.65 V to 5.5 V	1.65 V to 5.5 V			±1		±2	μΑ	
	A or B	V or V = 0 to 5.5	V	0 V	0 to 5.5 V			±1		±6		
I <sub>off</sub>	port	$V_{I}$ or $V_{O} = 0$ to 5.5	V  01 V() = 0 to 5.5 V		0 V			±1		±6	μΑ	
I <sub>OZ</sub>	A or B port	$\frac{V_O}{OE} = V_{CCO}$ or GND $\frac{V_O}{OE} = V_{IH}$	,	1.65 V to 5.5 V	1.65 V to 5.5 V			±1		±2	μΑ	
				1.65 V to 5.5 V	1.65 V to 5.5 V					15		
$I_{CCA}$		$V_I = V_{CCI}$ or GND,	$I_O = 0$	5 V	0 V					15	μΑ	
				0 V	5 V					-2		
				1.65 V to 5.5 V	1.65 V to 5.5 V					15		
$I_{CCB}$		$V_I = V_{CCI}$ or GND,	$I_O = 0$	5 V	0 V					-2	μΑ	
				0 V	5 V					15		
I <sub>CCA</sub> +	Іссв	$V_I = V_{CCI}$ or GND,	I <sub>O</sub> = 0	1.65 V to 5.5 V	1.65 V to 5.5 V					25	μΑ	
	A port	One A port at V <sub>CCA</sub> , DIR at V <sub>CCA</sub> , B por	_ 0.6 V, t = open							50		
ΔI <sub>CCA</sub>	DIR	DIR at V <sub>CCA</sub> - 0.6 B port = open, A port at V <sub>CCA</sub> or G		3 V to 5.5 V	3 V to 5.5 V					50	μΑ	
ΔI <sub>CCB</sub>	B port	One B port at V <sub>CCE</sub> DIR at GND, A por		3 V to 5.5 V	3 V to 5.5 V					50	μΑ	
C <sub>i</sub>	Control inputs	V <sub>I</sub> = V <sub>CCA</sub> or GND		3.3 V	3.3 V		4			5	pF	
C <sub>io</sub>	A or B port	$V_O = V_{CCA/B}$ or GN	D	3.3 V	3.3 V		8.5			10	pF	

 $<sup>\</sup>begin{array}{ll} \hbox{(1)} & V_{CCO} \text{ is the } V_{CC} \text{ associated with the output port.} \\ \hbox{(2)} & V_{CCI} \text{ is the } V_{CC} \text{ associated with the input port.} \\ \end{array}$ 

Submit Documentation Feedback

Product Folder Link(s): SN74LVC8T245-EP

Datasheet of SN74LVC8T245MPWREP - IC BUS TRANSCVR 8BIT 24TSSOP Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

SN74LVC8T245-EP



SCES770-DECEMBER 2008 www.ti.com

## **Switching Characteristics**

over recommended operating free-air temperature range,  $V_{CCA} = 1.8 \text{ V} \pm 0.15 \text{ V}$  (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	TO (OUTPUT)	V <sub>CCB</sub> = ± 0.1		V <sub>CCB</sub> = ± 0.2		V <sub>CCB</sub> = ± 0.	= 3.3 V .3 V	V <sub>CCB</sub> ± 0.		UNIT
	(INPUT)	(OUTPUT)	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t <sub>PLH</sub>	A	В	1.7	25.9	1.3	13.2	1	11.4	0.8	11.1	ns
t <sub>PHL</sub>	A	В	1.7	25.9	1.5	13.2	ı	11.4	0.6	11.1	115
t <sub>PLH</sub>	В	Λ	0.9	28.8	0.8	27.6	0.7	27.4	0.7	27.4	ns
t <sub>PHL</sub>	Б	A	0.9	20.0	0.6	21.0	0.7	21.4	0.7	21.4	115
$t_{PHZ}$	<del></del> <del>OE</del>	A	1.5	33.6	1.5	33.4	1.5	33.3	1.4	33.2	ns
$t_{PLZ}$	OE	A	1.5	33.0	1.5	33.4	1.5	33.3	1.4	33.2	115
$t_{PHZ}$	<del></del> <del>OE</del>	В	2.4	36.2	1.9	17.1	1.7	16	1 2	14.3	ns
$t_{PLZ}$	OE	Б	2.4	30.2	1.9	17.1	1.7	10	1.3	14.3	115
t <sub>PZH</sub>	<del></del> <del>OE</del>	А	0.4	28	0.4	27.8	0.4	27.7	0.4	27.7	ns
t <sub>PZL</sub>	OE	A	0.4	20	0.4	21.0	0.4	21.1	0.4	21.1	115
t <sub>PZH</sub>	ŌĒ	В		40	1.5	20	1.2	16.6	0.9	14.8	no
t <sub>PZL</sub>	J OE	В	1.8	40	1.5	20	1.2	10.0	0.9	14.8	ns

## **Switching Characteristics**

over recommended operating free-air temperature range,  $V_{CCA} = 2.5 \text{ V} \pm 0.2 \text{ V}$  (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CCB</sub> = ± 0.1		V <sub>CCB</sub> = ± 0.2		V <sub>CCB</sub> = ± 0.	= 3.3 V 3 V	V <sub>CCB</sub> ± 0.		UNIT
	(INFOT)	(OUTPUT)	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t <sub>PLH</sub>	A	В	1.5	25.4	1.2	13	0.8	10.2	0.6	8.8	ns
t <sub>PHL</sub>	^	В	1.5	25.4	1.2	13	0.0	10.2	0.0	0.0	115
t <sub>PLH</sub>	В	A	1.2	13.3	1	13.1	1	12.9	0.9	12.8	ns
t <sub>PHL</sub>	В	A	1.2	13.3	'	13.1	ı	12.9	0.9	12.0	115
t <sub>PHZ</sub>	ŌĒ	^	1.4	13	1.4	13	1.4	13	1.4	13	ns
t <sub>PLZ</sub>	OE	Α	1.4	13	1.4	13	1.4	13	1.4	13	115
t <sub>PHZ</sub>	ŌĒ	В	2.3	33.6	1.8	15	1.7	14.3	0.9	10.9	ns
t <sub>PLZ</sub>	OE	Ь	2.3	33.0	1.0	13	1.7	14.3	0.9	10.9	115
t <sub>PZH</sub>	ŌĒ	A	1	17.2	1	17.3	1	17.2	1	17.3	ns
t <sub>PZL</sub>	OE	A	'	17.2	ı	17.3	l	17.2	'	17.3	115
t <sub>PZH</sub>	ŌĒ	В	1.7	32.2	1.5	18.1	1.2	14.1	1	11.2	ns
t <sub>PZL</sub>	OE .	В	1.7	52.2	1.5	10.1	1.2	14.1	<u>'</u>	11.2	115

Submit Documentation Feedback

Datasheet of SN74LVC8T245MPWREP - IC BUS TRANSCVR 8BIT 24TSSOP

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com





www.ti.com SCES770-DECEMBER 2008

## **Switching Characteristics**

over recommended operating free-air temperature range,  $V_{CCA} = 3.3 \text{ V} \pm 0.3 \text{ V}$  (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	TO (OUTPUT)	V <sub>CCB</sub> = 1.8 V ± 0.15 V		V <sub>CCB</sub> = 2.5 V ± 0.2 V		V <sub>CCB</sub> = 3.3 V ± 0.3 V		V <sub>CCB</sub> = 5 V ± 0.5 V		UNIT
	(INPUT)	(OUTPUT)	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t <sub>PLH</sub>	A	В	1.5	25.2	1.1	12.8	0.8	10.3	0.5	10.4	ns
t <sub>PHL</sub>	A	Ь	1.5	25.2	1.1	12.0	0.6	10.3	0.5	10.4	10
t <sub>PLH</sub>	В	A	0.8	11.2	0.8	10.2	0.7	10.1	0.6	10	ns
t <sub>PHL</sub>	Б	A	0.8	11.2	0.6	10.2	0.7	10.1	0.0	10	10
$t_{PHZ}$	<del></del> <del>OE</del>	A	1.6	12.2	1.6	12.2	1.6	12.2	1.6	12.2	ns
$t_{PLZ}$	OE	A	1.0	12.2	1.0	12.2	1.0	12.2	1.0	12.2	10
$t_{PHZ}$	<del></del> <del>OE</del>	В	2.1	33	1.7	14.3	1.5	12.6	0.8	10.3	ns
$t_{PLZ}$	OE	Ь	2.1	33	1.7	14.3	1.5	12.0	0.0	10.3	115
$t_{PZH}$	<del></del> <del>OE</del>	A	0.8	14.1	0.8	13.6	0.8	13.2	0.8	13.6	ns
t <sub>PZL</sub>	JE JE	A	0.6	14.1	0.6	13.0	0.6	13.2	0.0	13.0	115
t <sub>PZH</sub>	ŌĒ	В	1.8	31.7	1.4	18.4	1.1	12.9	0.9	10.9	nc
t <sub>PZL</sub>	JE JE	В	1.0	31.7	1.4	10.4	1.1	12.9	0.9	10.9	ns

#### **Switching Characteristics**

over recommended operating free-air temperature range,  $V_{CCA} = 5 \text{ V} \pm 0.5 \text{ V}$  (unless otherwise noted) (see Figure 1)

		1 00A			`			, (	•	,	
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub> = ± 0.1		V <sub>CC</sub> = ± 0.	2.5 V 2 V	V <sub>CC</sub> = 3.3 V ± 0.3 V		V <sub>CC</sub> = 5 V ± 0.5 V		UNIT
	(INPUT)	(001701)	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t <sub>PLH</sub>	А	В	1.5	25.4	1	12.8	0.7	10	0.4	8.2	ns
t <sub>PHL</sub>	A	В	1.5	25.4	Į.	12.0	0.7	10	0.4	0.2	115
t <sub>PLH</sub>	В	A	0.7	11	0.4	8.8	0.3	8.5	0.3	8.3	ns
t <sub>PHL</sub>	В	^	0.7	11	0.4	0.0	0.5	0.5	0.5	0.5	113
t <sub>PHZ</sub>	ŌĒ	A	0.3	9.4	0.3	9.4	0.3	9.4	0.3	9.4	ns
$t_{PLZ}$	OE	A	0.3	9.4	0.5	9.4	0.3	9.4	0.3	9.4	115
$t_{PHZ}$	ŌĒ	В	2	32.7	1.6	13.7	1.4	12	0.7	9.7	ns
$t_{PLZ}$	OL	В	2	32.1	1.0	13.7	1.4	12	0.7	3.1	113
t <sub>PZH</sub>	ŌĒ	A	0.7	10.9	0.7	10.9	0.7	10.9	0.7	10.9	ns
$t_{PZL}$	OE	A	0.7	10.9	0.7	10.9	0.7	10.9	0.7	10.9	115
t <sub>PZH</sub>	ŌĒ	В	1.5	31.6	1.3	18.4	1	13.7	0.9	10.7	ns
$t_{PZL}$	OE OE	В	1.5	31.0	1.3	10.4	'	13.7	0.9	10.7	115

#### **Operating Characteristics**

 $T_A = 25^{\circ}C$ 

Α -							
	PARAMETER TEST CONDITIONS		VCCB = 1.0 V		V <sub>CCA</sub> = V <sub>CCB</sub> = 3.3 V	V <sub>CCA</sub> = V <sub>CCB</sub> = 5 V	UNIT
		CONDITIONS	TYP	TYP	TYP	TYP	
C <sub>pdA</sub> <sup>(1)</sup>	A-port input, B-port output		2	2	2	3	
C <sub>pdA</sub> , ,	B-port input, A-port output	$C_L = 0,$ f = 10 MHz,	12	13	13	16	pF
C <sub>pdB</sub> <sup>(1)</sup>	A-port input, B-port output	$t_r = t_f = 1 \text{ ns}$	13	13	14	16	рг
	B-port input, A-port output		2	2	2	3	

(1) Power dissipation capacitance per transceiver

Product Folder Link(s): SN74LVC8T245-EP

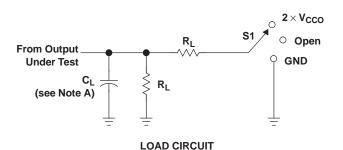
SN74LVC8T245-EP



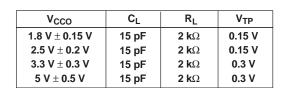
VCCA

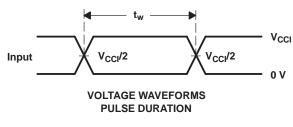
SCES770-DECEMBER 2008 www.ti.com

#### PARAMETER MEASUREMENT INFORMATION



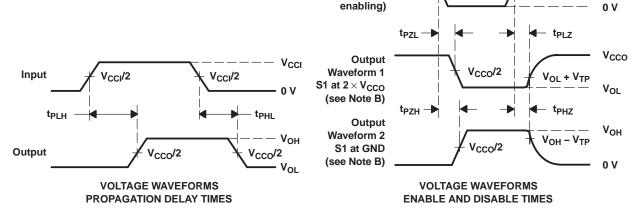
TEST	S1
t <sub>pd</sub>	Open
t <sub>PLZ</sub> /t <sub>PZL</sub>	2×V <sub>CCO</sub>
t <sub>PHZ</sub> /t <sub>PZH</sub>	GND





V<sub>CCA</sub>/2

V<sub>CCA</sub>/2



Output Control

(low-level

NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz, Z<sub>O</sub> = 50  $\Omega$ , dv/dt  $\geq$  1 V/ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
- F. t<sub>PZL</sub> and t<sub>PZH</sub> are the same as t<sub>en</sub>.
- G. t<sub>PLH</sub> and t<sub>PHL</sub> are the same as t<sub>pd</sub>.
- H.  $V_{CCI}$  is the  $V_{CC}$  associated with the input port.
- I.  $V_{CCO}$  is the  $V_{CC}$  associated with the output port.
- J. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

Submit Documentation Feedback



Datasheet of SN74LVC8T245MPWREP - IC BUS TRANSCVR 8BIT 24TSSOP Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

PACKAGE OPTION ADDENDUM

11-Apr-2013

#### PACKAGING INFORMATION

Orderable Device	Status	Package Type	•	Pins	-	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Top-Side Markings	Samples
	(1)		Drawing		Qty	(2)		(3)		(4)	
SN74LVC8T245MPWREP	ACTIVE	TSSOP	PW	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-55 to 125	NH245MEP	Samples
V62/09615-01XE	ACTIVE	TSSOP	PW	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-55 to 125	NH245MEP	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design. PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): Tl's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between

the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight

in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) Multiple Top-Side Markings will be inside parentheses. Only one Top-Side Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Top-Side Marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF SN74LVC8T245-EP:



Datasheet of SN74LVC8T245MPWREP - IC BUS TRANSCVR 8BIT 24TSSOP Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

PACKAGE OPTION ADDENDUM

11-Apr-2013

Catalog:	SN74L\	VC8T245
----------	--------	---------

• Automotive: SN74LVC8T245-Q1

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Automotive Q100 devices qualified for high-reliability automotive applications targeting zero defects

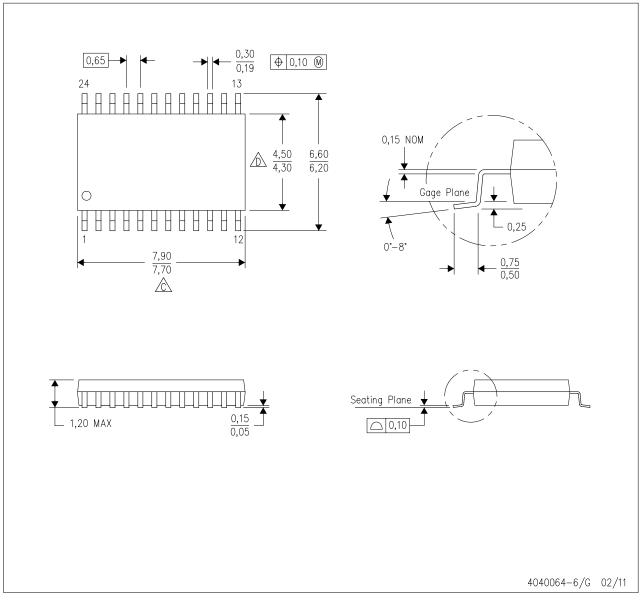
Addendum-Page 2



## **MECHANICAL DATA**

PW (R-PDSO-G24)

PLASTIC SMALL OUTLINE



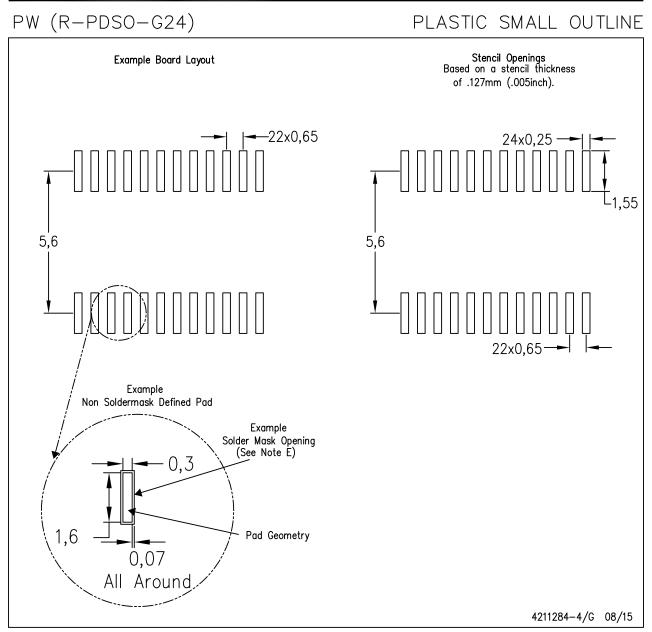
NOTES:

- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.
- E. Falls within JEDEC MO-153





#### **LAND PATTERN DATA**



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate design.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.





# **Distributor of Texas Instruments: Excellent Integrated System Limited**Datasheet of SN74LVC8T245MPWREP - IC BUS TRANSCVR 8BIT 24TSSOP

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

#### **IMPORTANT NOTICE**

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as "components") are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have *not* been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

#### Applications

Audio www.ti.com/audio Automotive and Transportation www.ti.com/automotive Amplifiers amplifier.ti.com Communications and Telecom www.ti.com/communications Computers and Peripherals **Data Converters** dataconverter.ti.com www.ti.com/computers **DLP® Products** Consumer Electronics www.ti.com/consumer-apps www.dlp.com DSP dsp.ti.com **Energy and Lighting** www.ti.com/energy Clocks and Timers www.ti.com/clocks Industrial www.ti.com/industrial Interface interface.ti.com Medical www.ti.com/medical

Power Mgmt Space, Avionics and Defense www.ti.com/space-avionics-defense

Security

www.ti.com/security

Microcontrollers microcontroller.ti.com Video and Imaging www.ti.com/video

RFID www.ti-rfid.com

**Products** 

Logic

OMAP Applications Processors www.ti.com/omap TI E2E Community e2e.ti.com

Wireless Connectivity www.ti.com/wirelessconnectivity

logic.ti.com

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2015, Texas Instruments Incorporated